

Data sheet Product FK 236 CB MI



Board Level heatsinks>Finger shaped heatsinks
for semiconductor-design TO 220

Features

Transistorbefestigung:	screw mounting
material:	aluminium
for transistor:	TO 220
width:	23.4 mm
length:	35.8 mm
thermal resistance:	18 K/W
surface:	solderable surface
version:	with solder lug for vertical installation

Technical Drawing

